Docket No.

## DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I ar (if plural nar entitled:	n the original, first and sole in nes are listed below) of the su	ventor (if only one name is bject matter which is claim	listed below) or an original, ed and for which a patent is so	first and joint inventor ought on the invention
PACKI	NG DEVICE FOR PLATE	E-LIKE ARTICLES	•	
the specifica	tion of which is attached heret	o unless the following is ch	necked	
was filed			Application Number or PCT	International
Application	on Number <u>PCT/JP02/10</u>		ended on <u>Aug. 6, 2003</u>	(if applicable).
I hereby state claim(s), as a	e that I have reviewed and und imended by any amendment re	erstand the contents of the	above-identified specification	, including the
l acknowledg Regulations,	ge the duty to disclose informa § 1.56.	ition which is material to pa	itentability as defined in Title	37, Code of Federal
for patent or	m foreign priority benefits und inventor's certificate listed be rtificate having a filing date be	low and have also identified	d below any foreign application	on for patent or
		, , , , , , , , , , , , , , , , , , ,	set when priority is elimined.	Priority Claimed
(List prior forei; applications, Se		Japan	19/June/2002	🛛 Yes 🗌 No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	the res [140
•				
	(Number)	(Country)	(Day/Month/Year Filed)	∐Yes ∐Ņo
	,		•	
	(Number)	(6)		☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B)	See attached list	for additional prior foreign	applications	
nsofar as the n the manner nformation w	n the benefit under Title 35, Usubject matter of each of the corprovided by the first paragra which is material to patentability ween the filing date of the	claims of this application is ph of Title 35, United State ity as defined in Title 37, C	not disclosed in the prior United Code, § 112, I acknowledge Code of Federal Regulations	ted States application e the duty to disclose 8 1.56 which became
List prior U.S. Applications)			Stati	ıs
	PCT/JP02/10221 (Application Serial No.)	19/June/2002 (Filing Date)	Patented Pend	ing Abandoned
	(A teppirounion derian 140.)	(i inig Date)		
			Patented Pend	ing 🔲 A bandoned
	(Application Serial No.)	(Filing Date)		•
			Patented Pend	ing $\square$ A bandoned
	(Application Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

23850 .
PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

patent issue	d thereon.	1 1	)			
See note C)		first inventor (given name, family name)	Takashi Yamamoto			
	Inventor's signature	Takada Yanamoto a	Date December 3, 2004			
		ka-shi, Osaka, Japan	Citizenship Japan			
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	Inventor's signature	Sotory Yamamoto Di	Date December 3, 2004			
•	Residence Sakai-	shi, Osaka, Japan	Citizenship Japan			
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		Otoriminamimachi 3-cho, Sak				
		ventor (given name, family name)				
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
	Full name of fourth inventor (given name, family name)					
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address	·				
	Full name of fifth inve	entor (given name, family name)				
•	Residence		Date			
	Post Office Address		Citizenship			
	-					
	-					